

L Number	Hits	Search Text	DB	Time stamp
1	1816	((((silicon adj based)(epoxy adj based))near3 resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:47
2	4006	((((silicon adj based)(epoxy adj based))near3 (encapsulant material resin))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:48
3	5058	((((silicon adj base\$1)(epoxy adj base\$1))near3 (encapsulant material resin))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:49
4	128	((((silicon adj based)(epoxy adj based))near3 resin)) near3 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:50
5	107	((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:50
6	186	((((silicon adj based)(epoxy adj based))near3 (encapsulant material resin))) near2 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:50
7	224	((((silicon adj base\$1)(epoxy adj base\$1))near3 (encapsulant material resin))) near2 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:50
8	224	(((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive) (((silicon adj based)(epoxy adj based))near3 (encapsulant material resin))) near2 adhesive (((silicon adj base\$1)(epoxy adj base\$1)) near3 (encapsulant material resin))) near2 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:50
9	10	(((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive) (((silicon adj based)(epoxy adj based))near3 (encapsulant material resin))) near2 adhesive (((silicon adj base\$1)(epoxy adj base\$1)) near3 (encapsulant material resin))) near2 adhesive with ((sealing adj (resin material)) encapsulation encapsulant encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:52
10	108	(((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive) (((silicon adj based)(epoxy adj based))near3 (encapsulant material resin))) near2 adhesive (((silicon adj base\$1)(epoxy adj base\$1)) near3 (encapsulant material resin))) near2 adhesive and (method process) and step	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/01/16 08:53

L Number	Hits	Search Text	DB	Time stamp
2	41	(US-5777391-\$ or US-RE36325-\$ or US-5502617-\$ or US-5506499-\$ or US-4992850-\$ or US-5347428-\$ or US-5138438-\$ or US-5678021-\$ or US-5541448-\$ or US-5691952-\$ or US-5915752-\$ or US-6239384-\$ or US-6291884-\$ or US-6300685-\$ or US-6081035-\$ or US-6054756-\$ or US-6191473-\$ or US-5994222-\$ or US-6027791-\$ or US-5719440-\$ or US-5937276-\$ or US-5398863-\$ or US-5536909-\$ or US-6279226-\$ or US-5998860-\$ or US-5936305-\$).did. or (US-5998865-\$ or US-6271586-\$ or US-5818698-\$ or US-6048755-\$ or US-6091140-\$ or US-5811879-\$ or US-6303219-\$ or US-6359221-\$ or US-5455390-\$ or US-6207477-\$ or US-6181569-\$ or US-5858815-\$ or US-6232152-\$ or US-6214640-\$ or US-5776796-\$).did.	USPAT	2002/08/12 07:45
7	7	("5107328" "5148265" "5422435" "5442231" "5519251" "5677566" "5684330").PN.	USPAT	2002/08/12 07:48
8	25	5777391.URPN.	USPAT	2002/08/12 07:48
9	15	("5045921" "5293068" "5384689" "5521427" "5536969" "5639695" "5679978" "5729051" "5773882" "5777391" "5844168" "5894107" "5999413" "6018188" "6057289").PN.	USPAT	2002/08/12 07:49
98	19	5776796.URPN.	USPAT	2002/08/12 08:01
99	65	("3390308" "3413713" "3614832" "3811183" "3868724" "3906144" "4012766" "4017495" "4143456" "4163072" "4300153" "4312116" "4374080" "4381602" "4536469" "4566184" "4616412" "4658332" "4701999" "4707724" "4710798" "4766670" "4829666" "4847146" "4857483" "4900501" "4913930" "4915607" "4918811" "4920074" "4953173" "4955132" "4999319" "5037779" "5052907" "5055913" "5075760" "5120678" "5130781" "5148265" "5148266" "5203076" "5249101" "5252784" "5258330" "5289346" "5302101" "5304252" "5304512" "5336931" "5355283" "5371044" "5385869" "5394009" "5409362" "5409865" "5409866" "5477611" "5483106" "5489749" "5518964" "5536909" "5563445" "5659952" "5706174" "DiStefano").PN.	USPAT	2002/08/12 08:03
100	40	4710798.URPN.	USPAT	2002/08/12 08:14
109	6	5776796.pn. 5663106.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 09:00
110	2	(5776796.pn. 5663106.pn.) and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 09:04
111	5	6232152.pn. 5834339.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 09:04

112	2	(6232152.pn. 5834339.pn.) and adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:18
113	9	("5120678" "5148265" "5148266" "5194930" "5203076" "5249101" "5288944" "5289346" "5385869").PN.	USPAT	2002/08/12 09:08
114	9	("3302067" "3474297" "4410905" "4751482" "4811082" "4878098" "4926241" "4967261" "4989069").PN.	USPAT	2002/08/12 09:10
119	203	5148265.URPN.	USPAT	2002/08/12 09:11
120	1624	((((silicon adj based)(epoxy adj based))near3 resin)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:25
121	112	((((silicon adj based)(epoxy adj based))near3 resin)) near3 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:31
122	93	((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:21
123	0	(((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive) with (encapsulation encapsulant encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:32
124	1	(((((silicon adj based)(epoxy adj based))near3 resin)) near2 adhesive) same(encapsulation encapsulant encapsulated encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:23
125	1	(((((silicon adj based)(epoxy adj based))near3 resin)) near3 adhesive) same(encapsulation encapsulant encapsulated encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:24
126	178	((((silicon adj based)(epoxy adj based))near3 resin)) with adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:24
127	2	(((((silicon adj based)(epoxy adj based))near3 resin)) with adhesive) same(encapsulation encapsulant encapsulated encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:24
128	3576	((((silicon adj based)(epoxy adj based)) near3 (encapsulant material resin))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:42
129	192	((((silicon adj based)(epoxy adj based)) near3 (encapsulant material resin))) near3 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:46
130	5	(((((silicon adj based)(epoxy adj based)) near3 (encapsulant material resin))) near3 adhesive) with (encapsulation encapsulant encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:46
131	4583	((((silicon adj base\$1)(epoxy adj base\$1)) near3 (encapsulant material resin))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:44
132	227	((((silicon adj base\$1)(epoxy adj base\$1)) near3 (encapsulant material resin))) near3 adhesive	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:46
133	5	(((((silicon adj base\$1)(epoxy adj base\$1)) near3 (encapsulant material resin))) near3 adhesive) with (encapsulation encapsulant encapsulating)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2002/08/12 10:46